

Bill of Materials

TI DESIGNS TIDA-00446

Small Form-Factor Reinforced Isolated IGBT Gate Drive Reference design for 3 Phase Inverter

Quantity	Designator	Description	Manufacturer	PartNumber	PackageReference	Fitted
1	!PCB	Printed Circuit Board	Any	TIDA-00446_E2		Fitted
24	C1, C2, C5, C10, C11, C21, C22, C23, C24, C25, C26, C30, C33, C34, C36, C40, C43, C45, C46, C50, C53, C54, C56, C60	CAP, CERM, 0.1 μF, 50 V, +/- 10%, X7R, 0603	MuRata	GRM188R71H104KA93D	0603	Fitted
6	C3, C12, C14, C35, C44, C55	CAP, CERM, 1 μF, 30 V, +/- 10%, X7R, 0603	TDK	C1608X7R1V105K080AC	0603	Fitted
	C4, C13, C28, C38, C48, C58, C64, C65, C66, C67, C68, C69	CAP, CERM, 10 μF, 35 V, +/- 10%, X7R, 1206_190	TDK	C3216X7R1V106K160AC	1206_190	Fitted
6	·	CAP, CERM, 10 μF, 10 V, +/- 20%, X6S, 0603	MuRata	GRM188C81A106MA73D	0603	Fitted
6	C7, C16, C29, C39, C49, C59	CAP, CERM, 220 pF, 50 V, +/- 10%, X7R, 0402	MuRata	GRM155R71H221KA01D	0402	Fitted
	C8, C9, C17, C18, C31, C32, C41, C42, C51, C52, C61, C62, C63	CAP, CERM, 22 pF, 50 V, +/- 1%, C0G/NP0, 0402	MuRata	GRM1555C1H220FA01D	0402	Fitted
1	C19	CAP, CERM, 47 µF, 16 V, +/- 20%, X5R, 1210	MuRata	GRM32ER61C476ME15L	1210	Fitted
1	C20	CAP, CERM, 4.7 μF, 10 V, +/- 10%, X7S, 0603	TDK	C1608X7S1A475K080AC	0603	Fitted
	D1, D3, D7, D9, D14, D17, D21, D23, D27, D29, D33, D35	Diode, Schottky, 40 V, 0.5 A, SOD-123	ON Semiconductor	MBR0540T1G	SOD-123	Fitted
6	D2, D8, D15, D22, D28, D34	Diode, Ultrafast, 1200 V, 1 A, SMA	STMicroelectronics	STTH112A	SMA	Fitted
6	D4, D10, D18, D24, D30, D36	Diode, Schottky, 40 V, 1 A, SOD-123	Diodes Inc.	1N5819HW-7-F	SOD-123	Fitted
6	D6, D12, D20, D26, D32, D38	Diode, Schottky, 30 V, 0.2 A, SOD-323	Diodes Inc.	BAT54WS-7-F	SOD-323	Fitted
1		Diode, Schottky, 40 V, 3 A, SMB	Diodes Inc.	B340LB-13-F	SMB	Fitted
5	H1, H2, H3, H4, H10	Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	B&F Fastener Supply	NY PMS 440 0025 PH	Screw	Fitted
5	H5, H6, H7, H8, H9	Standoff, Hex, 0.5"L #4-40 Nylon	Keystone	1902C	Standoff	Fitted
1	J1	Terminal Block, 2x1, 2.54mm, TH	TE Connectivity	282834-2	Terminal Block, 2x1, 2.54mm, TH	Fitted
1	J2	Header, 100mil, 6x2, Gold, TH	TE Connectivity	87227-6	Header, 6x2, 100mil, Gold	Fitted
6	J3, J4, J5, J6, J7, J8	Terminal Block, 3x1, 5.08 mm, TH	On-Shore Technology	OSTTA034163	3x1 Terminal Block	Fitted
1	Q1	Transistor, NPN, 30 V, 0.1 A, SOT-23	ON Semiconductor	BC848CLT1G	SOT-23	Fitted
6	R1, R6, R8, R21, R26, R31	RES, 10, 5%, 0.063 W, 0402	Vishay-Dale	CRCW040210R0JNED	0402	Fitted
6	R32	RES, 1.0 k, 5%, 0.125 W, 0805	Vishay-Dale	CRCW08051K00JNEA	0805	Fitted
6	R34	RES, 4.7, 5%, 0.33 W, 1206	Stackpole Electronics Inc		1206	Fitted
6	R7, R14, R20, R25, R30, R35	RES, 4.7, 5%, 0.25 W, 0805	Stackpole Electronics Inc	RPC0805JT4R70	0805	Fitted
1	R9	RES, 22 k, 5%, 0.1 W, 0603	Vishay-Dale	CRCW060322K0JNEA	0603	Fitted
2	R13, R36	RES, 100 k, 5%, 0.1 W, 0603	Vishay-Dale	CRCW0603100KJNEA	0603	Fitted
2	R16, R17	RES, 10 k, 5%, 0.063 W, 0402	Vishay-Dale	CRCW040210K0JNED	0402	Fitted
6	T1, T2, T3, T4, T5, T6	Transformer, 50 uH, SMT	Wurth Elektronik	750342879	9.14x8mm	Fitted
6		Low-Noise 1A Transformer Drivers for Isolated Power Supplies, DBV0006A	Texas Instruments	SN6505BDBVR	DBV0006A	Fitted
6	U2, U4, U6, U8, U10,	High-CMTI 2.5-A / 5-A Isolated IGBT, MOSFET Gate Driver with Active Safety Features, DW0016B	Texas Instruments	ISO5851DWR	DW0016B	Fitted
1	U13	150-mA, 6.5-V, 1-uA IQ Voltage Regulators with Enable, DRV0006A	Texas Instruments	TPS70633DRVR	DRV0006A	Fitted
6	D5, D11, D19, D25, D31, D37	·	OSRAM	LG L29K-G2J1-24-Z	1.7x0.65x0.8mm	Not Fitted
6		RES, 4.99 k, 1%, 0.063 W, 0402	Vishay-Dale	CRCW04024K99FKED	0402	Not Fitted

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